

Features

- Lead free
- RoHS compliant*
- Supports 15 KV IEC 61000-4-2 ESD equipment specification*
- Single device protects as many as 20 lines on exposed pins, communications ports
- Incorporates 40 bi-directional PN junction diodes
- Small form factor replaces 20 SOT23 packages

Thin Film on Silicon 2DEA Integrated ESD Protection Diode Array

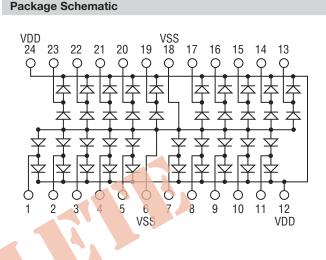
General Information

The Model 2DEA Series is well-suited for space constrained designs where the requirements of international ESD standard specification IEC 61000-4-2 must be met.

These highly integrated PN junction diode arrays are especially effective for use in PC notebooks and motherboards, engineering workstations and portable battery-powered devices such as PDAs and cellular phones.

Space savings, as compared to popular BA V99 SOT23 based implementations, can yield a 75 % reduction in utilized board area. In addition, significant assembly cost reductions and manufacturing integrity improvements can be realized.

Two package options are available. Model 2DEA consists of 20 bi-directional diode pairs in a miniature 24-pin JEDEC QSOP package. The 2DEB consists of 17 bi-directional diode pairs in a traditional wide-body SOIC JEDEC package.



Electrical Characteristics	Symbol	Minimum	Nominal	Maximum	Unit
Supply Voltage	V _{DD} - V _{SS}	-0.3		12	V
Voltage @ any Channel	V _{in}	-0.3		V _{DD} + 0.5	V
Channel Clamp Current (continuous)	ι _C			±15	mA
Forward Voltage:					
$@I_{f} = 1 \text{ mA}$	V _f		0.8	0.9	V
$@l_{f} = 12 \text{ mA}$				1.5	V
Leakage Current @ V _{SS} <v<sub>in<v<sub>DD = 12 V</v<sub></v<sub>			0.1	10	μA
Diode Capacitance				5	pF
Environmental Characteristics					
Operating Temperature	Тј	-55		+125	°C
Storage Temperature	T _{stg}	-65		+150	°C
Diode Power Rating			20		mW/diode
ESD Performance Withstand*:					
Contact Discharge		±8	±9		kV
Air Discharge		±15	±16		kV

Electrical & Environmental Characteristics

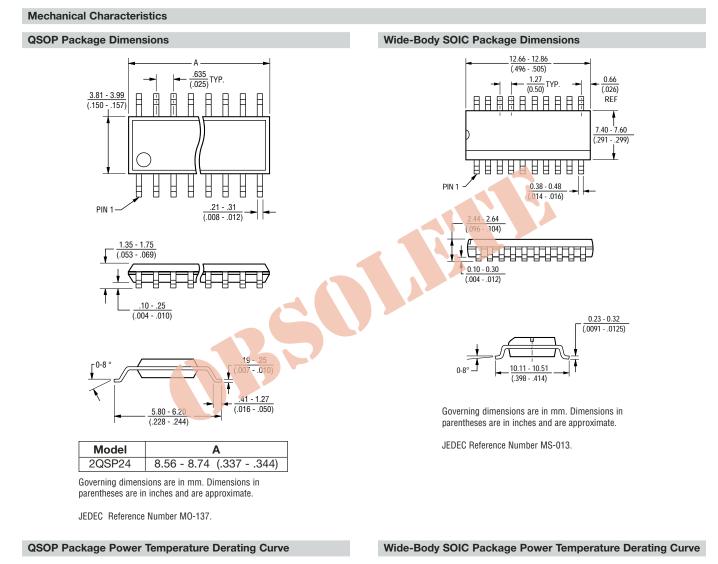
* Note: IEC 61000-4-2 ESD test performance is measured at the systems level and system designs, enclosure shielding and other conventional ESD control measures usually influence the results of these tests. Testing on the component level serves as an indicator that the system passes a specific compliance step, but does not ensure that the system passes at that level. The Model 2DEA/DEB device, therefore, can support successful implementation of the IEC 61000-4-2 system level ESD standard.

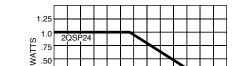
Applications

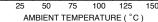
- Parallel printer ports, communication ports
- Hot-swappable designs
- IC protection

Thin Film on Silicon 2DEA Integrated ESD Protection Diode Array

BOURN







~

Standard Part Numbers

.50

.25

0

Part Number (Tape & Reel)	Part Number (Tubes)		
2DEA-2-Q24R	2DEA-2-Q24T		
2DEB-2-W20R	2DEB-2-W20T		

1.25

WATTS

1.0

.75

.50

.25

0

25 50 75 100 125

AMBIENT TEMPERATURE (° C)

Specifications are subject to change without notice.

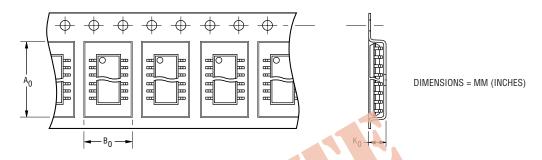
Customers should verify actual device performance in their specific applications.

Thin Film on Silicon 2DEA Integrated ESD Protection Diode Array

BOURNS®

Dispensing

For large quantities, the product will be dispensed in Tape and Reel (see diagram below).



Package	A ₀	B ₀	K ₀	Width	Pitch	No. of Pieces per 13 reel	No. of Pieces per tube
QSOP							
24 Pin	6.5 (0.256)	9.0 (0.354)	2.1 (0.083)	16 (0.630)	8 (0.315)	3,500	56
WBSOIC							
20 Pin	13 (0.519)	10.8 (0.425)	2.8 (0.110)	24 (0.945)	8 (0.315)	3,500	37

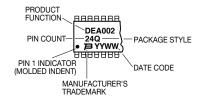
How To Order

	2 DEA - 2 -	Q 24 R LF
Product Class Thin-Film-on-Silicon		
Product Function ESD Protection Diode Array DEA = 20 Lines DEB = 17 Lines		
Standard		
Standard Package Style Q = QSOP W = Wide-Body SOIC		
Pin Count $Q = 24$ $W = 20$		
Dispensing R = Reel T = Tube		
Terminations		

LF = 100 % Sn (lead free)

Typical Part Marking

Represents total content. Layout may vary.





Reliable Electronic Solutions

Asia-Pacific: Tel: +886-2 2562-4117 • Fax: +886-2 2562-4116 Europe: Tel: +41-41 768 5555 • Fax: +41-41 768 5510 The Americas: Tel: +1-951 781-5500 • Fax: +1-951 781-5700 www.bourns.com